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DESCRIPTION

FIELD OF THE INVENTION

[0001] This invention relates to superhydrophobic materials, and more particularly to superhydrophobic coatings.

BACKGROUND OF THE INVENTION

[0002] Superhydrophobic coatings are typically only superhydrophobic at the coating's outer surface. Once the outer surface is abraded away, the surface is no longer superhydrophobic. This loss of superhydrophobicity is due to the superhydrophobic particles or structure being removed from the surface. Particles that are beneath the surface generally have their nanopores and nanotextured surfaces clogged with the underlying coating material.

[0003] In a standard electrostatic powder spraying process, dry resin powder, is electrostatically sprayed onto a given electrically grounded substrate. The electrically charged dry powder adheres to the grounded substrate by electrostatic forces. When the dry resin powder is cured, it becomes well bonded to the substrate.

[0004] WO 2009/012116 A2 disclose coating materials.

SUMMARY OF THE INVENTION

[0005] A superhydrophobic coating, comprising:

a hydrophobic thermoset resin powder; and

a plurality of superhydrophobic particles,

wherein each superhydrophobic particle comprises a hydrophilic porous core provided with a hydrophobic coating and has a three dimensional, nanostructured surface topology, defining a plurality of pores, the hydrophobic coating conforming to the surface of the superhydrophobic particle so as to preserve the nanostructured surface topology,

wherein at least a portion of the superhydrophobic particles are embedded within the cured thermal set resin so as to be surrounded by and mechanically bonded to the resin, and

wherein the pore volume of the superhydrophobic particle is less than 50% filled by the resin such that the three dimensional surface topology of the superhydrophobic particles is preserved.

[0006] The superhydrophobic particle can comprise a diatomaceous earth particle. Diatomaceous earth particles have a nanostructured surface topology. When, according to various embodiments, a diatomaceous earth particle is coated with a hydrophobic coating, the diatomaceous earth particle can retain its nanostructured surface topology even after being coated with the hydrophobic coating. According to the invention, the super hydrophobic particles have a porous core. The porous core of the superhydrophobic particles is hydrophilic. Diatomaceous earth is an example of a porous core that is naturally hydrophilic. The porous core of the superhydrophobic particles can be a silicate. The silicate can be etched to provide the nanostructured surface topology.

[0007] The resin into which the superhydrophobic particles are embedded is hydrophobic. A variety of polymers can be used as the resin. As used herein, the term "resin" means any solid or liquid synthetic or naturally occurring organic polymer and is not limited to materials obtained from naturally occurring exudations from certain plants.

[0008] The pore volume of the superhydrophobic particle is less than 50% filled by the resin. The diameter of the superhydrophobic particle can be between 0.1 - 20 μm or between 1 and 20 μm . The diameter of the superhydrophobic particles can be between 10 - 20 μm . For purposes of the present application, the term "pore volume" refers to a fraction of the volume of voids over the total volume of a particle. The term "pore volume" as used herein means the same as "porosity" or "void fraction." The pore volume can be expressed as either a fraction, between 0 and 1, or as a percentage, between 0 and 100%. The pore volume of a particle can be measured by any known method including direct methods, optical methods, computed tomography methods, imbibition methods, water evaporation methods, mercury intrusion porosimetry, gas expansion methods, thermoporosimetry, and cryoporometric methods.

[0009] The ratio of superhydrophobic particles to resin can be between 1:4 and 1:20 by volume, between 1:5 and 1:7 by volume, between 1:1 and 1:4 by volume, or between 1:1.5 and 1:2.5 by volume. For example, the ratio of superhydrophobic particles to resin can be about 1:6 by volume or about 1:2 by volume.

[0010] A precursor powder for a superhydrophobic coating can include a superhydrophobic powder having superhydrophobic particles and a plurality of resin particles. The superhydrophobic particles have a three dimensional surface topology comprising pores. The resin particles include a resin material, which is capable when cured, of surrounding and embedding the superhydrophobic particles, while not completely filling the pores of the superhydrophobic particles.

[0011] The diameter of the resin particles can be between 1 - 100 μm . According to certain embodiments, the diameter of the resin particles can be larger than the pore size of the superhydrophobic particles, but generally not more than 20 times the diameter of the superhydrophobic particles. According to certain embodiments, the diameter of the resin

particles can be larger than the pore size of the superhydrophobic particles, but not more than 4 times the diameter of the superhydrophobic particles. The diameter of the resin particles can be larger than average pore size of the superhydrophobic particles, but generally not more than 10 times the diameter of the superhydrophobic particles. According to other embodiments, the diameter of the resin particles can be larger than average pore size of the superhydrophobic particles, but generally not more than 2 times the diameter of the superhydrophobic particles.

[0012] A method for applying a superhydrophobic coating to a surface includes the step of providing a precursor powder for a superhydrophobic coating. The precursor powder has a plurality of superhydrophobic particles. The superhydrophobic particles have a three dimensional surface topology comprising pores. The precursor powder includes a plurality of resin particles. The resin particles include a resin material that is capable, when cured, of surrounding and embedding the superhydrophobic particles within the resin, but not completely filling the pores of the superhydrophobic particles. The precursor powder is applied to the surface. The resin is cured to bond the resin to the surface and to embed the superhydrophobic particles in the resin.

[0013] The resin is hydrophobic. The superhydrophobic particle includes a porous core material and a hydrophobic coating. The hydrophobic coating conforms to the surface of the porous core material so as to preserve the nanostructured surface topology. The porous core material is hydrophilic.

[0014] The porous core material can include a silicate. The silicate can be etched to provide a nanostructured surface topology. The porous core material can include diatomaceous earth. The pore volume of the superhydrophobic particle is less than 50% filled by the resin. The diameter of the superhydrophobic particle can be between 0.1 - 20 μm or about 1 μm . The diameter of the superhydrophobic particles can be between 10 - 20 μm . The ratio of superhydrophobic particles to resin can be between 1:4 and 1:20 by volume or between 1:1 and 1:4 by volume. The ratio of superhydrophobic particles to resin can be between 1:5 and 1:7 by volume or between 1:1.5 and 1:2.5 by volume. The ratio of superhydrophobic particles to resin can be about 1:6 by volume or about 1:2 by volume. A layer of resin particles can be applied to the surface prior to applying the precursor powder to the surface. The precursor powder can be applied to the surface by an electrostatic spraying process.

BRIEF DESCRIPTION OF THE DRAWINGS

[0015] There are shown in the drawings embodiments that are presently preferred it being understood that the invention is not limited to the arrangements and instrumentalities shown, wherein: Figures 1a - 1f are frames from a video demonstrating the superhydrophobicity of an aluminum power line coated according to one embodiment of the present invention.

DETAILED DESCRIPTION OF THE INVENTION

[0016] According to the invention superhydrophobic coating includes a superhydrophobic powder with superhydrophobic particles and a resin. The superhydrophobic particles have a three dimensional nanostructured surface topology defining pores. The superhydrophobic particles are embedded within the resin, such that at least some of the superhydrophobic particles are completely enveloped by or surrounded by the resin. As used herein the term "embedded" means to enclose firmly in a surrounding mass. The term "embedded" therefore includes not only particles that are completely surrounded or enveloped by the resin but also particles that are only partially enveloped, enclosed, or surrounded in the surrounded resin. According to various embodiments, a superhydrophobic coating can include a plurality of superhydrophobic particles that includes some completely embedded particles and some partially embedded particles. The completely embedded particles reside entirely within a resin layer such that they are surrounded on all sides by resin. The partially embedded particles have portions of their surface area protruding beyond the resin layer's surface. The protruding, partially embedded, particles can impart superhydrophobicity to the surface of the coating. The completely embedded particles allow the coating to remain superhydrophobic even after the surface of the coating is abraded or sanded away. When the surface of the coating is abraded or sanded away some or all of the partially embedded particles can be removed, but some or all of the completely embedded particles can be exposed at the surface of the coating. The exposed particles can then function to impart superhydrophobicity to the surface of the coating.

[0017] One reason that the completely embedded particles are able to maintain their superhydrophobicity once they are exposed to the surface after sanding or abrading is that despite being completely embedded within the resin, the resin does not completely fill the pores or completely cover the superhydrophobic particles. Since the resin does not completely fill the pores or completely cover the superhydrophobic particles, the three dimensional surface topology of the superhydrophobic particles is preserved. The resin can be capable of being melted and blended with the superhydrophobic (SH) particles without completely filling the pores of the superhydrophobic particles and/or without covering all of the nanotextured surfaces of the superhydrophobic particles. According to certain embodiments, the superhydrophobic particles can repel the resin to preserve a volume of air within the porous core of each superhydrophobic particle. The degree to which the resin does fill the pores of the superhydrophobic particles shall be defined in more detail hereinafter.

[0018] Various embodiments describe how to modify existing electrostatic spray powder coating techniques such that the resulting coating is well-bonded, durable, and superhydrophobic (SH). Various embodiments combine dry powder resins with superhydrophobic, nano-textured amorphous silica powder to form a well-bonded coating that is both superhydrophobic at the surface and is still superhydrophobic when the outer surface is abraded away, for example, by sanding the outer surface.

[0019] Additional embodiments relate to a precursor powder comprising super hydrophobic particles and resin particles.

Superhydrophobic Particles

[0020] Each of the superhydrophobic particles comprise a hydrophobic coating. The hydrophobic coating can conform to the surface of each superhydrophobic particle, so as to preserve the nanostructured surface topology.

[0021] The superhydrophobic particles include a porous core and/or a porous core material. The porous core and/or the porous core material is hydrophilic. The porous core and/or the porous core material of the superhydrophobic particles can be a silicate. The silicate can be etched to provide the nanostructured surface topology. According to some embodiments the superhydrophobic particle can comprise one or more diatomaceous earth particles. The surface chemistry of the porous core and/or the porous core material can be changed from hydrophilic to hydrophobic by the application of a hydrophobic coating. The hydrophobic coating conforms to the surface of the porous core material, so as to preserve the nanostructured surface topology.

[0022] The diameter of any or all of the superhydrophobic particles and/or the average diameter of the superhydrophobic particles can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 0.05, 0.1, 0.5, 1, 1.5, 2, 2.5, 3, 3.5, 4, 4.5, 5, 5.5, 6, 6.5, 7, 7.5, 8, 8.5, 9, 9.5, 10, 10.5, 11, 11.5, 12, 12.5, 13, 13.5, 14, 14.5, 15, 15.5, 16, 16.5, 17, 17.5, 18, 18.5, 19, 19.5, 20, 20.5, 21, 21.5, 22, 22.5, 23, 23.5, 24, 24.5, and 25 μm at one atmosphere pressure. For example, according to certain preferred embodiments, the diameter of any or all of the superhydrophobic particles and/or the average diameter of the superhydrophobic particles can be from 0.1 - 20 μm , from 1 - 20 μm , or from 10 - 20 μm .

[0023] The pore volume of any or all of the superhydrophobic particles and/or the average pore volume of the superhydrophobic particles can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 0.01, 0.02, 0.03, 0.04, 0.05, 0.06, 0.07, 0.08, 0.09, 0.1, 0.11, 0.12, 0.13, 0.14, 0.15, 0.16, 0.17, 0.18, 0.19, 0.2, 0.21, 0.22, 0.23, 0.24, 0.25, 0.26, 0.27, 0.28, 0.29, 0.3, 0.31, 0.32, 0.33, 0.34, 0.35, 0.36, 0.37, 0.38, 0.39, 0.4, 0.41, 0.42, 0.43, 0.44, 0.45, 0.46, 0.47, 0.48, 0.49, and 0.5 ml/g. For example, according to certain preferred embodiments, the pore volume of any or all of the superhydrophobic particles and/or the average pore volume of the superhydrophobic particles can be 0.1 - 0.3 ml/g.

[0024] The surface area of any or all of the superhydrophobic particles and/or the average surface area of any or all of the superhydrophobic particles can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 0.5, 1, 5, 10, 15, 20, 25, 30, 35, 40, 45, 50, 55, 60, 65, 70, 75, 80, 85, 90, 95, 100, 105, 110, 115, and 120 m^2/gm . For

example, according to certain preferred embodiments, the surface area of any or all of the superhydrophobic particles and/or the average surface area of any or all of the superhydrophobic particles can be 1 - 100 m²/gm.

[0025] Differentially etched spinodal superhydrophobic powders are described in detail in US Patent No. 7,258,731 to D'Urso et al., issued on August 21, 2007, and consists of nano-porous and nanotextured silica (once the borate has been etched away). Such differentially etched spinodal superhydrophobic powders can be employed as the superhydrophobic particles according to various embodiments.

[0026] Superhydrophobic diatomaceous earth (SHDE) is described in detail US Patent No. 8,216,674 to Simpson et al., issued on July 10, 2012). Such superhydrophobic diatomaceous earth particles can be employed as the superhydrophobic particles according to various embodiments

Resin

[0027] According to the invention, the resin is hydrophobic. One example of a suitable hydrophobic resin is fluorinated ethylene propylene (FEP). Other embodiments can employ Ultra-violet (UV) curable resins, thermoset resins, and thermoplastic. UV curable resins are particularly preferred for certain purposes, because they can allow for the coating of various thermal sensitive substrates, such as plastics, waxes, or any material that might melt or soften at the curing temperature used for other resins. According to certain embodiments, it can be advantageous to use hydrophobic resins (like FEP) of electrostatic powder coat resins commercially available including, thermal set resins, thermal plastic resins, and UV curable resins. Combinations of various types of resins can also be employed.

[0028] Resins can include, but are not limited to, polypropylene; polystyrene; polyacrylate; polycyanoacrylates; polyacrylates; polysiloxanes; polyisobutylene; polyisoprene; polyvinylpyrrolidone; epoxy resins, polyester resins (also known as TGIC resins), polyurethane resins, polyvinyl alcohol; styrene block copolymers; block amide copolymers; amorphous fluoropolymer, such as that sold by E. I. du Pont de Nemours and Company ("DuPont") under the TEFLON AF[®] trademark; acrylic copolymer, alkyd resin mixtures, such as those sold by Rohm and Haas under the FASTRACK XSR[®] trademark, and copolymers and mixtures thereof.

[0029] The resins can include further components, including tackifiers, plasticizers and other components.

[0030] In general, the smaller the resin powder grain size, the more uniform the superhydrophobic powder dispersion. The same is true for the superhydrophobic powder grain size. It should be noted, however, that according to certain embodiments, if the resin grains

become too small (<1 micron) it is more likely that the resins will begin to fill the pores of the superhydrophobic powder and cover up too much of the surface texture of the superhydrophobic powder.

[0031] Superhydrophobic powder grains can have a diameter within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 10, 15, 20, 30, 40, 50, 60, 70, 80, 90, 100, 200, 300, 400, 500, 600, 700, 800, 900, 1000, 1500, 2000, 2500, 3000, 3500, 4000, 4500, 5000, 5500, 6000, 6500, 7000, 7500, 8000, 8500, 9000, 9500, 10000, 10500, 11000, 11500, 12000, 12500, 13000, 13500, 14000, 14500, 15000, 15500, 16000, 16500, 17000, 17500, 18000, 18500, 19000, 19500, 20000, 20500, 21000, 21500, 22000, 22500, 23000, 23500, 24000, 24500, and 25000 nm. For example, according to certain preferred embodiments, superhydrophobic powder grains can have a diameter within range of from 20 nm to 20 microns, or from 100 nm to 15 microns.

[0032] The diameter of the resin particles can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 0.01, 0.05, 0.1, 0.5, 1, 2, 3, 4, 5, 10, 15, 20, 25, 30, 35, 40, 45, 50, 55, 60, 65, 70, 75, 80, 85, 90, 95, 100, 105, 110, 115, and 120 μm . For example, according to certain preferred embodiments, the diameter of the resin particles can be between 1 - 100 μm .

[0033] The diameter of the resin particles can be larger than the pore size of the superhydrophobic particles by a factor within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 1, 10, 100, 200, 300, 400, 500, 600, 700, 800, 900, 1000, 1100, 1200, 1300, 1400, 1500, 1600, 1700, 1800, 1900, 2000, 2100, 2200, 2300, 2400, 2500, 2600, 2700, 2800, 2900, 3000, 3100, 3200, 3300, 3400, 3500, 3600, 3700, 3800, 3900, 4000, 4100, 4200, 4300, 4400, 4500, 4600, 4700, 4800, 4900, and 5000. For example, according to certain preferred embodiments, the diameter of the resin particles can be larger than the pore size of the superhydrophobic particles by a factor within a range of from 1 to 5000. The resin particles could be as small as the silica pore size (~20nm pore size) and as large as 5000 times as large as the pores (i.e. 100 microns).

[0034] The diameter of the resin particles can be larger than the diameter of the superhydrophobic particles by a factor within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1, 1.1, 1.2, 1.3, 1.4, 1.5, 1.6, 1.7, 1.8, 1.9, 2, 2.1, 2.2, 2.3, 2.4, 2.5, 2.6, 2.7, 2.8, 2.9, 3, 3.1, 3.2, 3.3, 3.4, 3.5, 3.6, 3.7, 3.8, 3.9, 4, 4.1, 4.2, 4.3, 4.4, and 4.5. For example, according to certain preferred embodiments, the diameter of the resin particles can be larger than the diameter of the superhydrophobic particles by a factor within a range of from 0.1 to 4.

[0035] According to some embodiments, the diameter of the resin particles can be larger than

the pore size of the superhydrophobic particles but generally not more than 20 times the diameter of the superhydrophobic particles. According to other embodiments the diameter of the resin particles can be larger than average pore size of the superhydrophobic particles but generally not more than 10 times the diameter of the superhydrophobic particles.

Composition of the Superhydrophobic Coating

[0036] The ratio of superhydrophobic particles to resin in the superhydrophobic coating, by volume can be selected from 1:1, 1:1.25, 1:1.5, 1:1.75, 1:2, 1:2.25, 1:2.5, 1:2.75, 1:3, 1:3.25, 1:3.5, 1:3.75, 1:4, 1:4.25, 1:4.5, 1:4.75, 1:5, 1:5.25, 1:5.5, 1:5.75, 1:6, 1:6.25, 1:6.5, 1:6.75, 1:7, 1:7.25, 1:7.5, 1:7.75, 1:8, 1:8.25, 1:8.5, 1:8.75, 1:9, 1:9.25, 1:9.5, 1:9.75, 1:10, 1:10.25, 1:10.5, 1:10.75, 1:11, 1:11.25, 1:11.5, 1:11.75, 1:12, 1:12.25, 1:12.5, 1:12.75, 1:13, 1:13.25, 1:13.5, 1:13.75, 1:14, 1:14.25, 1:14.5, 1:14.75, and 1:15. For example, according to certain preferred embodiments, the ratio of superhydrophobic particles to resin in the superhydrophobic coating can be between 1:1 and 1:10, by volume. The ratio of superhydrophobic particles to resin can be between 1:1.5 and 1:5, by volume. The ratio of superhydrophobic particles to resin can be about 1:4, by volume.

[0037] The pore volume of any or all of superhydrophobic particle that is filled by the resin can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 0.1, 0.5, 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16, 17, 18, 19, 20, 21, 22, 23, 24, 25, 26, 27, 28, 29, 30, 31, 32, 33, 34, 35, 36, 37, 38, 39, 40, 41, 42, 43, 44, 45, 46, 47, 48, 49, 50, 51, 52, 53, 54, 55, 56, 57, 58, 59, and 60 %. For example, according to certain preferred embodiments, the pore volume of any or all of superhydrophobic particle can be less than 50% filled by the resin.

[0038] Superhydrophobic powder grains, like superhydrophobic diatomaceous earth, are generally much lighter than resin grains of comparable size because of the superhydrophobic powder grain's high porosity and surface area. In addition, the superhydrophobic diatomaceous earth powder grains described in this invention are generally much smaller than the typical resin grains. For instance, resin grain sizes typically vary from about 30 microns to 100 microns in diameter, while superhydrophobic diatomaceous earth typically varies from 0.5 microns to 15 microns in diameter. This means that equal volumes of superhydrophobic diatomaceous earth and resin powder consist of considerably more SHDE grains and will contain much more resin by weight.

Precursor powder

[0039] A precursor powder for a superhydrophobic coating comprises a superhydrophobic powder having superhydrophobic particles and a plurality of resin particles. The

superhydrophobic particles each have a three dimensional surface topology comprising pores. The resin particles comprise a resin material, which, when cured, can be capable of embedding the superhydrophobic particles within the resin, but does not completely fill the pores of the superhydrophobic particles.

[0040] Superhydrophobic silicon dioxide (silica) nanoparticles can have a diameter within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 0.1, 0.5, 1, 2, 3, 4, 5, 10, 15, 20, 25, 30, 35, 40, 45, 50, 55, 60, 65, 70, 75, 80, 85, 90, 95, 100, 105, 110, 115, 120, and 125 nm. For example, according to certain preferred embodiments, superhydrophobic silica nanoparticles can have a diameter of from 1 nm to 100 nm. Superhydrophobic silica nanoparticles are typically spherical or approximately spherical and have diameters of less than 100 nm in size. The silica particles can have a diameter that is as small as a few nanometers, but often conglomerate into compound particles microns in size.

[0041] The diameter of particle conglomerates can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 100, 150, 200, 300, 400, 500, 600, 700, 800, 900, 1000, 1100, 1200, 1300, 1400, 1500, 1600, 1700, 1800, 1900, 2000, 2100, 2200, 2300, 2400, 2500, 2600, 2700, 2800, 2900, 3000, 3100, 3200, 3300, 3400, 3500, 3600, 3700, 3800, 3900, 4000, 4100, 4200, 4300, 4400, 4500, 4600, 4700, 4800, 4900, 5000, 5100, 5200, 5300, 5400, and 5500 nm. For example, according to certain preferred embodiments, the diameter of particle conglomerates can be from 200 nm to 5 microns.

[0042] Once the superhydrophobic particles and the resin particles are blended to form the precursor powder, the precursor powder can be directly sprayed (electrostatically) onto a substrate (usually a metal).

[0043] The substrate can then be preheated to a temperature within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 75, 80, 85, 90, 95, 100, 105, 110, 115, 120, 125, 130, 135, 140, 145, 150, 155, 160, 165, 170, 175, 180, 185, 190, 195, 200, 205, 210, 215, 220, 225, 230, 235, 240, 245, 250, 255, 260, 265, 270, 275, 280, 285, 290, 295, and 300 degrees Fahrenheit (convert to °C by subtracting 32 and then dividing by 1.8). For example, according to certain preferred embodiments, the substrate can then be preheated to a temperature within a range of from 100 degrees Fahrenheit to 250 degrees Fahrenheit. This temperature range can correspond to the low end of the curing temperature range. The preheating step can allow the substrate to approach the curing temperature of the resin before the resin cures.

[0044] Once the substrate is within 1, 2, 3, 4, 5, 6, 7, 8, 9, or 10 degrees Fahrenheit of the curing temperature, the temperature can be elevated to the normal curing temperature range, which can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be

selected from 225, 230, 235, 240, 245, 250, 255, 260, 265, 270, 275, 280, 285, 290, 295, 300, 305, 310, 315, 320, 325, 330, 335, 340, 345, 350, 355, 360, 365, 370, 375, 380, 385, 390, 395, 400, 405, 410, 415, 420, 425, 430, 435, 440, 445, 450, 455, 460, 465, 470, 475, 480, 485, 490, 495, and 500 degrees Fahrenheit. For example, according to certain preferred embodiments, once the substrate is within 10 degrees Fahrenheit of the curing temperature, the temperature can be elevated to the normal curing temperature range, which can be from 250 degrees Fahrenheit to 450 degrees Fahrenheit. Once at curing range, the temperature can be held for a time period. The time period can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16, 17, 18, 19, 20, 21, 22, 23, 24, 25, 26, 27, 28, 29, and 30 minutes. For example, according to certain preferred embodiments, the time period can be from about 10 to 15 minutes. Since the substrate is typically already at or near the curing temperature, this increase in temperature readily increases the substrate temperature and allows the resin to sufficiently bond to the substrate.

[0045] The superhydrophobic powder is mechanically bonded to the resin, because the resin partially penetrates into its porous nanotextured structure during the curing process. If the powder were cured at the curing temperature without waiting for the substrate to warm up, the thermal mass of the substrate and insulation attributes of superhydrophobic particles, such as superhydrophobic diatomaceous earth, would prevent the substrate from heating up to the curing temperature before the resin cured. The result would be an unbonded superhydrophobic resin film that would simply fall off the substrate.

Application process

[0046] A method for applying a superhydrophobic coating to a surface includes the step of providing a precursor powder for a superhydrophobic coating. The precursor powder has a plurality of superhydrophobic particles. The superhydrophobic particles have a three dimensional surface topology comprising pores. The precursor powder also includes a plurality of resin particles. The resin particles include a resin material that is capable, when cured, of embedding the superhydrophobic particles within the resin, but not filling the pores of the superhydrophobic particles or completely covering the particle surface. The precursor powder is applied to the surface. The resin is cured to bond the resin to the surface and to embed the superhydrophobic particles in the resin.

[0047] The precursor powder can be applied by a spray-on process.

[0048] The precursor powder can be applied by dipping a hot substrate into a blended resin/superhydrophobic powder that would cause the blend to coat and cure on the substrate. The hot substrate can be maintained at a temperature within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 175, 180, 185, 190, 195, 200, 205, 210,

215, 220, 225, 230, 235, 240, 245, 250, 255, 260, 265, 270, 275, 280, 285, 290, 295, 300, 305, 310, 315, 320, 325, 330, 335, 340, 345, 350, 355, 360, 365, 370, 375, 380, 385, 390, 395, 400, 405, 410, 415, 420, 425, 430, 435, 440, 445, and 450 degrees Fahrenheit. For example, according to certain preferred embodiments, the hot substrate can be maintained at a temperature in a range of 200 degrees Fahrenheit to 400 degrees Fahrenheit for a time period. The time period can be within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16, 17, 18, 19, 20, 21, 22, 23, 24, 25, 26, 27, 28, 29, and 30 minutes. For example, according to certain preferred embodiments, the time period can be from about 10 to 15 minutes.

[0049] Preheating the substrate can be important due to the thermal insulating effects of the superhydrophobic silica powder. The fact that the dry powder blend contains a thermally insulating silica powder (e.g. SHDE) means that it will likely be more difficult to get the substrate up to a temperature that promotes curing. If the substrate is prevented from reaching the curing temperature in the allotted curing time (because of the SH silica powder blend) then the coating might not adequately bond to the substrate.

[0050] The same type of coating/curing can be done with a hot substrate engulfed on a cloud of swirling powder. In this embodiment, the hot substrate can be maintained at a temperature within a range having a lower limit and/or an upper limit. The range can include or exclude the lower limit and/or the upper limit. The lower limit and/or upper limit can be selected from 175, 180, 185, 190, 195, 200, 205, 210, 215, 220, 225, 230, 235, 240, 245, 250, 255, 260, 265, 270, 275, 280, 285, 290, 295, 300, 305, 310, 315, 320, 325, 330, 335, 340, 345, 350, 355, 360, 365, 370, 375, 380, 385, 390, 395, 400, 405, 410, 415, 420, 425, 430, 435, 440, 445, and 450 degrees Fahrenheit. For example, according to certain preferred embodiments, the hot substrate can be maintained at a temperature in a range of 200 degrees Fahrenheit to 400 degrees Fahrenheit.

[0051] There are many possible variations for depositing the superhydrophobic powder. In a process having only one application step, the dry powder resin and superhydrophobic particles can be blended together. The superhydrophobic particles can be superhydrophobic diatomaceous earth (SHDE), but other nanostructured superhydrophobic powders can be used, such as silica nanoparticles, and differentially etched spinodal decomposed borosilicate glass powder. Mixtures of different types of superhydrophobic particles are also possible.

[0052] A layer of resin particles can be applied to the surface prior to applying the precursor powder to the surface. The precursor powder can be applied to the surface by an electrostatic spraying process.

Rejuvenation process

[0053] Various embodiments relate to a method of rejuvenating a superhydrophobic surface.

The superhydrophobic surface is a surface according to any of the preceding embodiments. The super hydrophobic surface can be prepared according to any of the preceding embodiments and comprises a resin; and a plurality of superhydrophobic particles. Each superhydrophobic particle have a three dimensional, nanostructured surface topology, defining a plurality of pores. At least a portion of the superhydrophobic particles are embedded within the resin or chemically bonded to the resin so as to be surrounded by the resin. According to the invention, the resin does not fill the pores of the embedded superhydrophobic particles such that the three dimensional surface topology of the superhydrophobic particles is preserved. The method of rejuvenating a super hydrophobic surface comprises simply abrading the superhydrophobic surface to expose the embedded superhydrophobic particles.

[0054] Again, superhydrophobic powder grains, like superhydrophobic diatomaceous earth, are generally much lighter than resin grains of comparable size because of the superhydrophobic powder grain's high porosity and surface area. In addition, the superhydrophobic diatomaceous earth powder grains described in this invention are generally much smaller than the typical resin grains. For instance, resin grain sizes typically vary from about 30 microns to 100 microns in diameter, while superhydrophobic diatomaceous earth typically varies from 0.5 microns to 15microns in diameter. This means that equal volumes of superhydrophobic diatomaceous earth and resin powder consist of considerably more SHDE grains and will contain much more resin by weight.

[0055] When a drop of water is surrounded by superhydrophobic silica powder very small powder grains can be somewhat sticky to the drop and can produce a thin film of such powder grains on the drop's surface. Such water drops covered with SH silica are called "water marbles." These water marbles generally will not combine with each other because of the repulsive effects of the SH powder. The same effect can occur to the curing powder resins according to various embodiments to form resin marbles. Each resin marble can be covered with a plurality of superhydrophobic particles. In some cases formation of resin marbles is desirable. Resin marbles are typically unable to be bonded to the substrate or with other resin marbles. For other applications, formation of resin marbles should be avoided by limiting the amount of superhydrophobic particles (for example, silica powder) blended with the resins.

[0056] To avoid or to reduce formation of resin marbles, the ratio of superhydrophobic particles to resin in the superhydrophobic coating can be selected from 1:1, 1:1.25, 1:1.5, 1:1.75, 1:2, 1:2.25, 1:2.5, 1:2.75, 1:3, 1:3.25, 1:3.5, 1:3.75, 1:4, 1:4.25, 1:4.5, 1:4.75, 1:5, 1:5.25, 1:5.5, 1:5.75, 1:6, 1:6.25, 1:6.5, 1:6.75, 1:7, 1:7.25, 1:7.5, 1:7.75, 1:8, 1:8.25, 1:8.5, 1:8.75, 1:9, 1:9.25, 1:9.5, 1:9.75, 1:10, 1:10.25, 1:10.5, 1:10.75, 1:11, 1:11.25, 1:11.5, 1:11.75, 1:12, 1:12.25, 1:12.5, 1:12.75, 1:13, 1:13.25, 1:13.5, 1:13.75, 1:14, 1:14.25, 1:14.5, 1:14.75, 1:15, 1:15.25, 1:15.5, 1:15.75, 1:16, 1:16.25, 1:16.5, 1:16.75, 1:17, 1:17.25, 1:17.5, 1:17.75, 1:18, 1:18.25, 1:18.5, 1:18.75, 1:19, 1:19.25, 1:19.5, 1:19.75, 1:20, 1:20.25, 1:20.5, 1:20.75, 1:21, 1:21.25, 1:21.5, 1:21.75, 1:22, 1:22.25, 1:22.5, 1:22.75, 1:23, 1:23.25, 1:23.5, 1:23.75, 1:24, 1:24.25, 1:24.5, 1:24.75, and 1:25 by volume. For example, according to certain preferred embodiments, the ratio of superhydrophobic particles to resin in the superhydrophobic coating can be between 1:8 and 1:15 by volume, corresponding to about 1:3

and 1:10 by weight. The ratio of superhydrophobic particles to resin can be between 1:1.5 and 1:5 by volume or about 1:4, by volume.

[0057] Ratios of superhydrophobic particles to resin in the superhydrophobic coating can also be expressed by weight. To avoid or to minimize formation of resin marbles, the ratio of superhydrophobic particles to resin in the superhydrophobic coating can be selected from 1:1, 1:1.25, 1:1.5, 1:1.75, 1:2, 1:2.25, 1:2.5, 1:2.75, 1:3, 1:3.25, 1:3.5, 1:3.75, 1:4, 1:4.25, 1:4.5, 1:4.75, 1:5, 1:5.25, 1:5.5, 1:5.75, 1:6, 1:6.25, 1:6.5, 1:6.75, 1:7, 1:7.25, 1:7.5, 1:7.75, 1:8, 1:8.25, 1:8.5, 1:8.75, 1:9, 1:9.25, 1:9.5, 1:9.75, 1:10, 1:10.25, 1:10.5, 1:10.75, 1:11, 1:11.25, 1:11.5, 1:11.75, 1:12, 1:12.25, 1:12.5, 1:12.75, 1:13, 1:13.25, 1:13.5, 1:13.75, 1:14, 1:14.25, 1:14.5, 1:14.75, 1:15, 1:15.25, 1:15.5, 1:15.75, 1:16, 1:16.25, 1:16.5, 1:16.75, 1:17, 1:17.25, 1:17.5, 1:17.75, 1:18, 1:18.25, 1:18.5, 1:18.75, 1:19, 1:19.25, 1:19.5, 1:19.75, 1:20, 1:20.25, 1:20.5, 1:20.75, 1:21, 1:21.25, 1:21.5, 1:21.75, 1:22, 1:22.25, 1:22.5, 1:22.75, 1:23, 1:23.25, 1:23.5, 1:23.75, 1:24, 1:24.25, 1:24.5, 1:24.75, and 1:25 by weight. For example, the ratio of superhydrophobic particles to resin in the superhydrophobic coating can be from about 1:3 to about 1:9 by weight.

[0058] The preferred ratios depend on both the resin grain sizes and the superhydrophobic powder grain sizes. For instance, if superhydrophobic particles having an average size of 10 microns was employed in conjunction with a resin having an average size of 50 microns, a preferred ratio of superhydrophobic particles to resin could be about 1:8 by weight. If the superhydrophobic particles were much smaller, for example, 1.0 micron diameter, and the resin was 50 microns, a preferred ratio of superhydrophobic particles to resin could be 1:20 by weight. In other words, if the superhydrophobic particles have a smaller diameter, then on either a weight basis or on a volume basis much less superhydrophobic would be needed to avoid or to reduce formation of resin marbles.

EXAMPLES

EXAMPLE 1

[0059] DuPont's Vulcan Black thermal set dry resin powder was blended with superhydrophobic diatomaceous earth (SHDE) particles. This blend was then electrostatically sprayed onto an electrically grounded substrate (usually a metal). The silica-based powders accept and hold an electrostatic charge very well, better in fact, than the dry resin powders themselves. Once the blended powder was electrostatically attached to the grounded substrate, the substrate was heated in an oven using a temperature that is on the low end of the powder resin's curing temperature range. For the thermal set Vulcan Black resin the curing temperature was 320 degrees Fahrenheit, which is about 20 degrees Fahrenheit less than a normal low temperature curing temperature. In general, the curing temperature can be 20 degrees Fahrenheit below the lowest manufacturer's suggested curing temperature.

[0060] SHDE acts as a slight thermal insulator. When blended SHDE is applied to the substrate, it will tend to inhibit substrate heating. Therefore, it is necessary, when using thermal set or thermal plastic powder resins, to preheat the substrate before curing, in order to insure good resin-to-substrate adhesion during curing. The preheating step consists of heating the coated substrate to a temperature slightly less than the low end of the resin curing temperature. A temperature of 20 degrees Fahrenheit below the manufacturer's lowest recommended curing temperature was employed. In the case of Vulcan Black (VB), a preheat temperature of 320 degrees Fahrenheit was used. The preheat temperature is held for a suitable amount of time such as 10 minutes. Once the substrate was preheated the oven temperature was raised to the normal curing temperature (400 degrees Fahrenheit for 20 minutes, for VB).

[0061] The heating of the substrate and precursor powder can be by any suitable method. Conductive or convective heating is possible, as is radiant heating, microwave (RF) heating, and possibly also nuclear heating could be used, among others. Since the substrate is already close to the curing temperature, an increase in temperature at this point readily increases the metal substrate temperature and allows the resin to sufficiently bond to the substrate.

EXAMPLE 2

[0062] In the second variation, a two powder application step process was used. The dry resin powder, according to example 1, was electrostatically sprayed onto the substrate in a standard electrostatic powder coat process. Next, a SHDE/dry resin precursor powder blend was sprayed onto the substrate. Once both powder layers are electrostatically adhered to the substrate, the layers were cured together in the same manner as described previously. This second method provided good bonding to the substrate and increases overall coating durability while maintaining a high quality superhydrophobic surface and some abrasion resistance.

[0063] While these two application variations and associated set of steps reflect current processing steps, it is in no way to be considered the only way to coat the substrate. The precursor powder can be used and incorporated into many other powder coat processes.

[0064] If the substrate is not preheated before exposing the coating to the curing temperature, the thermal mass of the substrate and insulation attributes of SHP would inhibit the substrate from heating properly to the curing temperature before the resin cures. The result would be an unbonded SHP/resin film that would simply fall off the substrate.

[0065] A key feature of this process is the fact that the SHP is not actually chemically bonded to the curing resin. During the resin curing process the flowing resin does not completely "wet" the superhydrophobic particles, such as superhydrophobic diatomaceous earth. In fact, the superhydrophobic particles actually can somewhat repel the curing resin. This keeps the pores of the superhydrophobic particles generally unclogged and full of air. But, some of the curing

resin does flow into the porous nanotextured structure such as pores. Once cured, the resin that went into the pores mechanically holds the SHP in place, effectively bonding the superhydrophobic particles to and below the surface.

RESULTS OF EXAMPLES 1 AND 2

[0066] Using the blended superhydrophobic powder coating techniques described in examples 1 and 2; both aluminum and steel plates were successfully coated along with small aluminum power-line segments.

[0067] Based on these results, it should be clear that any metal (especially electrically conductive metals), can be coated. Additionally, by using standard powder coating techniques of applying a conductive primer coating, paper, wood, cloth, plastics, etc. have been successfully powder coated and thus could be made superhydrophobic with our enhancements to such powder coatings.

EXAMPLE 3

[0068] Superhydrophobic diatomaceous earth (SHDE) was blended with three parts (by weight) of DuPont's thermal set resin Vulcan Black (VB) of to electrostatically coat a power line segment. First, the powerline was electrostatically sprayed with VB. Then, a blend of VB and SHDE, having a 3:1 volume ratio, was electrostatically sprayed onto the powerline.

[0069] The combined coatings were cured at 200 degrees Celsius for 30 minutes. The result was a well-bonded superhydrophobic surface that maintained superhydrophobic behavior even when the outer layers were abraded away. A Taber abrasion test according to ASTM D 4060, showed superhydrophobic behavior after as many as 400 (fully loaded) Tabor cycles.

[0070] Results from the Taber Abrasion test are summarized in Table 1.

Table 1	
Taber Cycles	Contact Angle with a drop of water
0	165°
10	160°
50	158°
100	158°
200	155°
300	153°
400	151°
450	135°

[0071] Figures 1a - 1f are still frames taken from a video showing water droplets rolling off of the coated powerline. These still frames demonstrate that the powerline was successfully rendered superhydrophobic.

EXAMPLE 4

[0072] A variety of powder blend combinations, comprising a resin and a plurality of superhydrophobic particles have been successfully made. These include polyester (TGIC) resins like Vulcan Black, Oil Black (From DuPont), and Safety Yellow (from Valspar), epoxy resins like PCM90133 Black Epoxy Powder from PPG, and fluoropolymer powder resins like PD800012 Powder Duranar AAMA2605 from PPG.

[0073] All of these resins were blended with SHDE and testing for superhydrophobic behavior. All of the above resins and associated blends of SHDE were able to be bonded to a variety of substrates (glass, wood, and aluminum) and exhibited contact angles in excess of 150 degrees. Tabor abrasion testing was done on coated aluminum plates coated with all the about resin/SHDE blends. Superhydrophobicity was maintained on these plates for Taber (minimal loading) cycles exceeding 100 cycles.

[0074] One powder blend combination comprised DuPont's thermal set resin Vulcan Black (VB) Resin and superhydrophobic diatomaceous earth (SHDE) at ratios of 3:1, and 4:1. It was discovered that as the ratio of Resin:SHDE increases (i.e. lower concentrations of SHDE) the degree of water repellency (i.e. contact angle) decreases, but some enhanced water repellency (over the bare resin) is expected at all SHDE concentrations (even very low concentrations). At the other extreme (i.e. as Resin:SHDE ratio approaches zero i.e. the blend is entirely SHDE), most of the SHDE powder did not get bonded to the coating, except at the interface of the SHDE layer and the first resin application layer. The result is a very superhydrophobic surface without a great deal of durability. That is, a small amount of abrasion will remove the surface bond SHDE. Once that's removed, the surface is no longer superhydrophobic.

[0075] Based on these results it can be reasonably concluded that a blend comprising as little as 5% SHDE by volume could result in good superhydrophobic behavior (contact angles of >150 degrees). As the blended proportion of SHDE increases, water repellency increases. The blending of SHDE with resin also creates a volumetric SH effect, in that removal of some coating material, by mild abrasion, exposes fresh (not fully clogged) SHDE material and thus the abraded surface remains SH.

[0076] Blends resulting in a good superhydrophobic behavior can have an amount of superhydrophobic diatomaceous earth within a range of from 1 to 90% by weight. Preferred blends can comprise from 10% to 30% SHDE by weight or from 10% to 20% SHP by weight.

For purposes of this example the term "good superhydrophobic behavior" means that when the blend is applied to a substrate according to various embodiments the resulting super hydrophobic coating has a contact angle with a drop of water in a range of from 150 degrees to 175 degrees, and a roll-off angle in a range of from 0.1 degree to 15 degrees.

REFERENCES CITED IN THE DESCRIPTION

Cited references

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Patent documents cited in the description

- [WO2009012116A2 \[0004\]](#)
- [US7258731B \[0025\]](#)
- [US8216674B \[0026\]](#)

Patentkrav**1.** Superhydrofob belægning, der omfatter:

et hydrofobt termohærdende harpikspulver, og

5 en flerhed af superhydrofobe partikler,

hvor hver superhydrofob partikel omfatter en hydrofil porøs kerne
tilvejebragt med en hydrofob belægning og har en tredimensionel,
nanostruktureret overfladetopologi, der definerer en flerhed af po-
rer, idet den hydrofobe belægning tilpasser sig den superhydrofobe
10 partikels overflade for således at bevare den nanostrukturerede
overfladetopologi,

hvor i det mindste en del af de superhydrofobe partikler er indlejret
i den hærdede termohærdende harpiks for således at være omgivet
af og mekanisk bundet til harpiksen, og

15 hvor den superhydrofobe partikels porevolumen er mindre end
50 % fyldt med harpiksen, således at de superhydrofobe partiklers
tredimensionelle overfladetopologi bevares.

2. Superhydrofob belægning ifølge krav 1, hvor den superhydrofobe parti-
kel omfatter en diatoméjordpartikel.

20

3. Superhydrofob belægning ifølge krav 1, hvor den porøse kerne er et si-
likat.

4. Superhydrofob belægning ifølge krav 3, hvor silikatet er ætset med
25 henblik på at tilvejebringe den nanostrukturerede overfladetopologi.

5. Superhydrofob belægning ifølge krav 1, hvor den superhydrofobe parti-
kels diameter er på mellem 1-20 μm .

- 6.** Superhydrofob belægning ifølge krav 1, hvor de superhydrofobe partiklers diameter er på mellem 10-20 μm .
- 5 **7.** Superhydrofob belægning ifølge krav 1, hvor volumenforholdet mellem superhydrofobe partikler og harpiks er på mellem 1:1 og 1:10.
- 8.** Superhydrofob belægning ifølge krav 1, hvor volumenforholdet mellem superhydrofobe partikler og harpiks er på mellem 1:1,5 og 1:5.
- 10 **9.** Superhydrofob belægning ifølge krav 1, hvor volumenforholdet mellem superhydrofobe partikler og harpiks er på ca. 1:4.
- 10.** Precursorpulver til en superhydrofob belægning ifølge krav 1, der omfatter:
- 15 en flerhed af superhydrofobe partikler, som har en tredimensionel overfladetopologi, der omfatter porer, og
- en flerhed af harpikspartikler, idet harpiksen, når den er hærdet, er i stand til at indlejre de superhydrofobe partikler i harpiksen, men ikke fylde de superhydrofobe partiklers porer,
- 20 hvor harpikspartiklernes diameter er større end af de superhydrofobe partiklers porestørrelse, men ikke mere end 4 gange de superhydrofobe partiklers diameter, og
- hvor harpiksen er hydrofob.
- 25 **11.** Precursorpulver til en superhydrofob belægning ifølge krav 10, hvor harpikspartiklerne er mellem 1-100 μm .
- 12.** Precursorpulver til en superhydrofob belægning ifølge krav 10, hvor harpikspartiklernes diameter er større end de superhydrofobe partiklers gennemsnitlige porestørrelse, men ikke mere end 2 gange de superhydrofobe partiklers diameter.
- 30

13. Fremgangsmåde til påføring af en superhydrofob belægning ifølge krav 1 på en overflade, hvilken fremgangsmåde omfatter følgende trin:

tilvejebringelse af et precursorpulver ifølge krav 10,

påføring af precursorpulveret på overfladen, og

5 hærdning af harpiksen med henblik på at binde harpiksen til overfladen og indlejre de superhydrofobe partikler i harpiksen, hvor den superhydrofobe partikels porevolumen fyldes mindre end 50 % med harpiksen.

14. Fremgangsmåde ifølge krav 13, hvor den superhydrofobe partikel
10 omfatter et porøst kernemateriale og en hydrofob belægning, idet den hydrofobe belægning tilpasser sig det porøse kernemateriales overflade for således at bevare den nanostrukturerede overfladetopologi.

15. Fremgangsmåde ifølge krav 13, hvor det porøse kernemateriale om-
15 fatter et silikat.

16. Fremgangsmåde ifølge krav 15, hvor silikatet ætzes med henblik på at tilvejebringe en nanostruktureret overfladetopologi.

17. Fremgangsmåde ifølge krav 13, hvor det porøse kernemateriale om-
20 fatter diatoméjord.

18. Fremgangsmåde ifølge krav 13, hvor den superhydrofobe partikels di-
25 ameter er på mellem 1-20 μm .

19. Fremgangsmåde ifølge krav 13, hvor de superhydrofobe partiklers di-
ameter er på mellem 10-20 μm .

20. Fremgangsmåde ifølge krav 13, hvor volumenforholdet mellem super-
30 hydrofobe partikler og harpiks er på mellem 1:1 og 1:4.

- 21.** Fremgangsmåde ifølge krav 13, hvor volumenforholdet mellem superhydrofobe partikler og harpiks er på mellem 1:1,5 og 1:2,5.
- 5 **22.** Fremgangsmåde ifølge krav 13, hvor volumenforholdet mellem superhydrofobe partikler og harpiks er på ca. 1:2.
- 23.** Fremgangsmåde ifølge krav 13, hvor et lag af harpikspartikler påføres på overfladen før påføring af precursorpulveret på overfladen.
- 10 **24.** Fremgangsmåde ifølge krav 13, hvor precursorpulveret påføres på overfladen ved hjælp af en elektrostatisk sprøjteproces.
- 25.** Fremgangsmåde til foryngelse af en superhydrofob belægning ifølge krav 1,
- 15 hvilken fremgangsmåde omfatter slibning af den superhydrofobe overflade med henblik på at blotlægge de indlejrede superhydrofobe partikler.

DRAWINGS

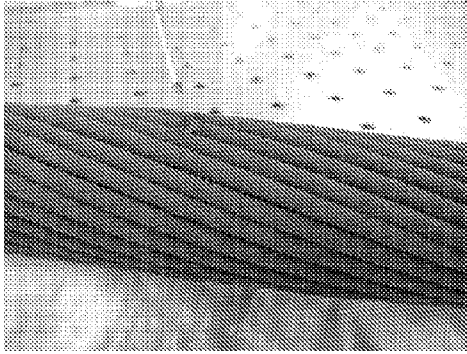


FIG. 1a

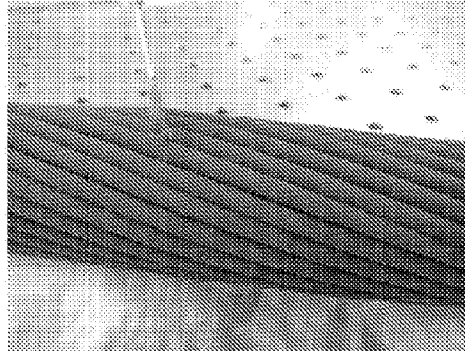


FIG. 1b

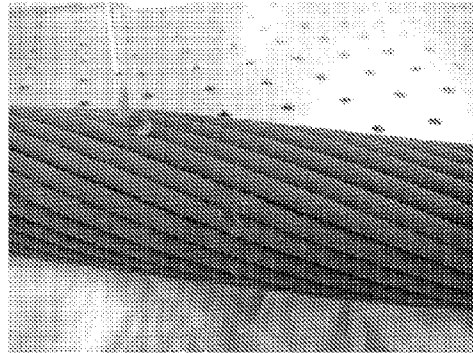


FIG. 1c

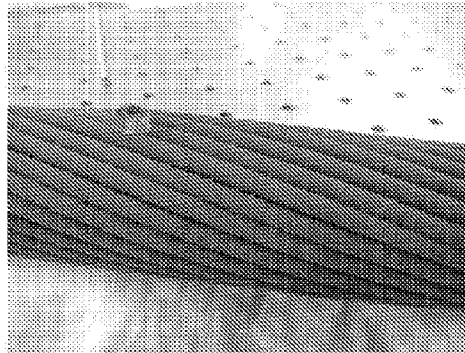


FIG. 1d

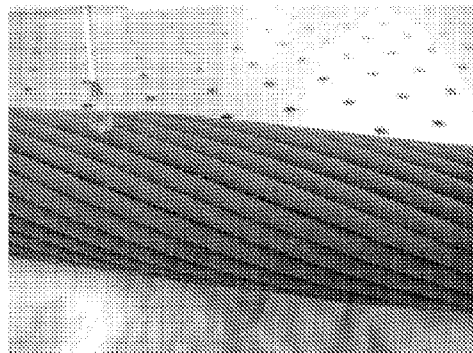


FIG. 1e

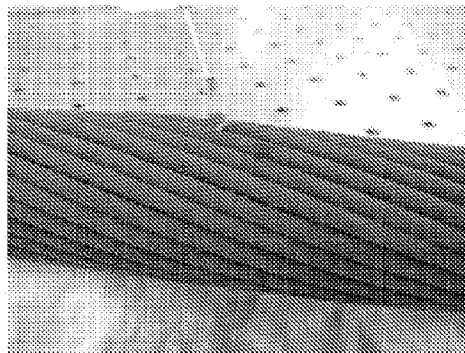


FIG. 1f